



### SiC Diode

### Features

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / no forward recovery
- Temperature independent switching behaviour
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Pb-free lead plating; RoHS compliant

### **Potential applications**

- Drives
- Industrial power supplies: Industrial UPS
- Solar central inverters and Solar string inverter

### **Product validation**

• Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

### Description

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- Related Links: <u>www.infineon.com/SiC</u>

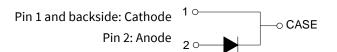




#### Key performance parameters

Туре	V <sub>DC</sub>	IF	Qc	T <sub>vj,max</sub>	Marking	Package
IDK16G120C5	1200 V	16 A	57nC	175°C	D1612C5	PG-TO263-2







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**Maximum ratings** 

## 1 Maximum ratings

Note:

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage $T_{\rm C} \ge 25^{\circ}{\rm C}$	V <sub>RRM</sub>	1200	V
Continuous forward current for $R_{th(j-c,max)}$ $T_c = 145^{\circ}C, D=1$ $T_c = 135^{\circ}C, D=1$ $T_c = 25^{\circ}C, D=1$	/ <sub>F</sub>	16 19 40	A
Surge repetitive forward current, sine halfwave <sup>1</sup> $T_c=25^{\circ}C$ , $t_p=10ms$ $T_c=100^{\circ}C$ , $t_p=10ms$	I <sub>F,RM</sub>	64 48	A
Surge non-repetitive forward current, sine halfwave $T_c=25$ °C, t <sub>p</sub> =10ms $T_c=150$ °C, t <sub>p</sub> =10ms	I <sub>F,SM</sub>	140 120	A
Non-repetitive peak forward current $T_c = 25^{\circ}C, t_p=10 \mu s$	I <sub>F,max</sub>	850	A
i <sup>2</sup> t value $T_{c} = 25^{\circ}C, t_{p}=10 \text{ ms}$ $T_{c} = 150^{\circ}C, t_{p}=10 \text{ ms}$	∫i²dt	99 71	A <sup>2</sup> s
Diode dv/dt ruggedness V <sub>R</sub> =0960 V	dv/dt	150	V/ns
Power dissipation for $R_{th(j-c,max)}$ $T_c = 25^{\circ}C$	P <sub>tot</sub>	250	W

Datasheet P
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<sup>&</sup>lt;sup>1</sup> Not subject to production test. The test was performed with 20000 pulses (two consecutive half-wave rectified sines with 10 ms period).



#### Maximum ratings

Operating temperature	T <sub>vj</sub>	-55175	°C
Storage temperature	T <sub>stg</sub>	-55150	°C
Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STD-020)	$T_{sold}$	260	°C



Thermal resistances

#### **Thermal resistances** 2

Parameter	Symbol	Conditions	Value			Unit	
Parameter	Symbol	Conditions	min.	typ.	max.		
Characteristic	Characteristic						
Diode thermal resistance, junction – case	R <sub>th(j-c)</sub>		-	0.46	0.60	K/W	
Thermal resistance, junction – ambient	$R_{th(j-a)}$	Leaded	-	-	62	K/W	



**Electrical Characteristics** 

#### **Electrical Characteristics** 3

#### Static Characteristics, at $T_{\nu j} \mbox{=} 25^\circ \mbox{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol		min.	typ.	max.	Unit
DC blocking voltage	V <sub>DC</sub>	<i>T</i> <sub>vj</sub> = 25°C, I <sub>R</sub> =50μA	1200	-	-	V
Diode forward voltage	17	<i>I</i> <sub>F</sub> = 16A, <i>T</i> <sub>νj</sub> =25°C	-	1.65	1.95	V
	VF	<i>I</i> <sub>F</sub> = 16A, <i>T</i> <sub><i>vj</i></sub> =150°C	-	2.25	-	
Reverse current	1	V <sub>R</sub> =1200V, <i>T</i> <sub>vj</sub> =25°C	-	5.5	80	μA
	/ <sub>R</sub>	<i>V</i> <sub>R</sub> =1200V, <i>T</i> <sub>vj</sub> =150°C	-	28	-	

#### Dynamic Characteristics, at $T_{\nu j} {=} 25^\circ C$ , unless otherwise specified

Parameter	Symbol	Conditions		Value		
Parameter	Symbol		min.	typ.	max.	Unit
Total capacitive charge		V <sub>R</sub> =800V, <b>T</b> <sub>vj</sub> =150°C				
	Qc	$Q_C = \int_0^{V_R} C(V) dV$	-	57	-	nC
		<i>V</i> <sub>R</sub> =1 V, <i>f</i> =1 MHz	-	730	-	
Total Capacitance	С	<i>V</i> <sub>R</sub> =400 V, <i>f</i> =1 MHz	-	52	-	pF
		<i>V</i> <sub>R</sub> =800 V, <i>f</i> =1 MHz	-	40	-	



**Electrical Characteristics Diagrams** 



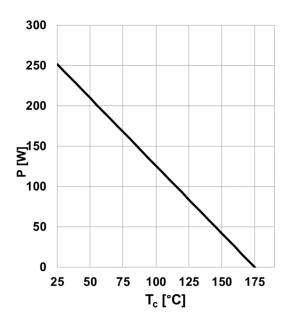


Figure 1. Power dissipation as function of case temperature, Ptot=f(Tc), Rth(j-c),max

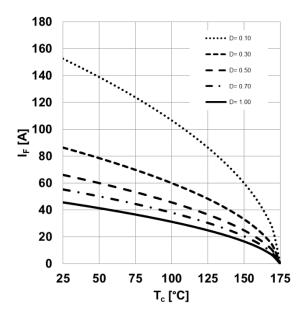


Figure 2. Diode forward current as function of temperature, parameter:  $T_{vi} \leq 175^{\circ}C$ , R<sub>th(j-c),max</sub>, D=duty cycle, V<sub>th</sub>, R<sub>diff</sub> @ T<sub>vj</sub>=175°C

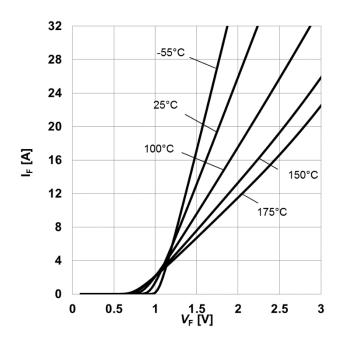


Figure 3. Typical forward characteristics,  $I_{\rm F}=f(V_{\rm F}), t_{\rm p}=10 \,\mu {\rm s}, {\rm parameter}: T_{\rm vj}$ 

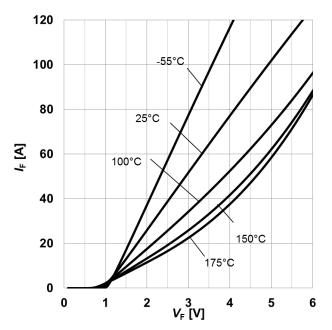


Figure 4. Typical forward characteristics in surge current,  $I_F = f(V_F)$ ,  $t_p = 10 \mu s$ , parameter:  $T_{v_j}$ 



#### **Electrical Characteristics Diagrams**

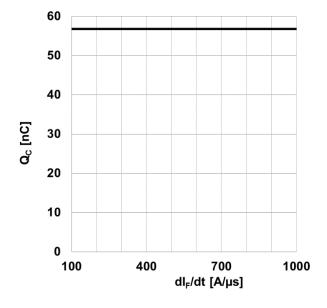
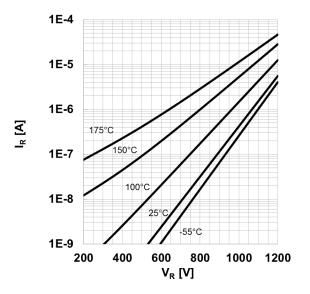


Figure 5. Typical capacitive charge as function of current slope,  $Q_c=f(dIF/dt)$ ,  $T_{vi}=150^{\circ}C$ 





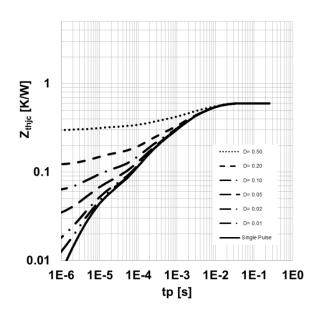


Figure 7. Max. transient thermal impedance,  $Z_{th,j-c}=f(t_P)$ , parameter: D=tP/T

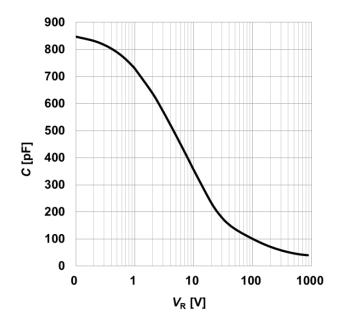


Figure 8. Typical capacitance as function of reverse voltage, C=f(V<sub>R</sub>);  $T_{vj}$ =25°C; f=1 MHz



#### **Electrical Characteristics Diagrams**

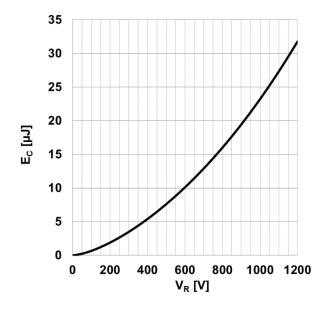


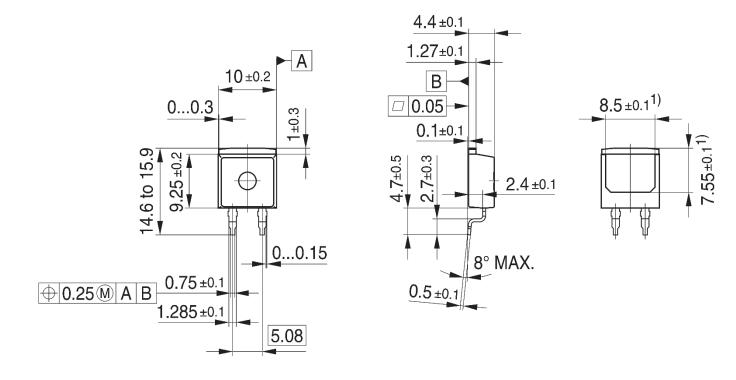
Figure 9. Typical capacitively stored energy as function of reverse voltage,  $E_c=f(V_R)$ 



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### Package Drawing

PG-TO263-2



1) Typical

Metal surface min. X = 7.25, y = 6.9All metal surfaces: tin plated, except area of cut

All dimensions do not include mold flash or protrusions All dimensions are in units mm The drawings is in complicance with ISO 128-30, Projection Method 1 [-□++]



### **Revision history**

Document version	Date of release	Description of changes
V 2.0	2019-10-28	Final Datasheet
V 2.1	2021-07-14	Increased dv/dt ruggedness

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